

2MBI100S-120

IGBT Modules

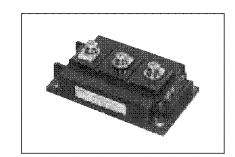
IGBT MODULE (S series) 1200V / 100A / 2 in one package

■ Features

High speed switching Voltage drive Low Inductance module structure

■ Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as Welding machines



■ Maximum Ratings and Characteristics

Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions		Maximum ratings	Units
Collector-Emitter voltage	Vces			1200	V
Gate-Emitter voltage	VGES			±20	V
Collector current	la la	Continuous	Tc=25°C	150	
	IC IC		Tc=80°C	100	
		1ms	Tc=25°C	300	
	lc pulse		Tc=80°C	200	Α
	-lc			100	
	-lc pulse	1ms		200	
Collector power dissipation	Pc	1 device		780	W
Junction temperature	Tj			150	°C
Storage temperature	Tstg			-40 to +125	°C
Isolation voltage (*1)	Viso	AC: 1min.		2500	V
Screw torque	Mounting (*2)			3.5	N·m
	Terminals (*2)			4.5] 14.111

Note *1: All terminals should be connected together when isolation test will be done.

Note *2: Recommendable value : Mounting : 2.5-3.5 N·m (M5 or M6), Terminals : 3.5-4.5 N·m (M6)

● Electrical characteristics (at Tj= 25°C unless otherwise specified)

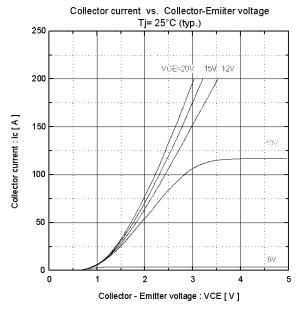
Items	Symbols	Conditions		Characteristics			Units
Itellia	Olimaiz			min.	typ.	max.	UIIIIS
Zero gate voltage collector current	lces	V _{3E} = 0V, V _{CE} = 1200V		-	-	2.0	mA
Gate-Emitter leakage current	lees	Voe = 0V, Voe = ±20V		_	-	0.4	μA
Gate-Emitter threshold voltage	VGE (In)	Vc= = 20V, Ic = 100mA		5.5	7.2	8.5	V
Collector-Emitter saturation voltage	V	V _{3E} = 15V I _c = 100A	Tj=25°C	_	2.3	2.6	V
	VcE (988)		Tj=125°C	-	2.8		
Input capacitance	Cies	V ₂₅ = 0V		-	12000		
Output capacitance	Coes	V _{CE} = 10V		_	2500	-	pF
Reverse transfer capacitance	Cres	f = 1MHz		-	2200		
Turn-on time	ton			-	0.35	1.2	
	tr	√cc = 600V		_	0.25	0.6	ĺ
	tr (i)	c = 100A V _{0E} = ±15V R ₀ = 9.1Ω		_	0.1		µs
Turn-off time	toff			-	0.45	1.0	
	tf			_	0.08	0.3	
Forward on voltage	.,	I 400A	Tj=25°C	_	2.3	3.0	V
	Vr	- = 100A	Tj=125°C	_	2.0	-	
Reverse recovery time	trr	I= = 100A	<u>'</u>	-	_	0.35	μs

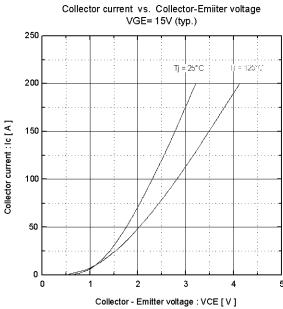
Thermal resistance characteristics

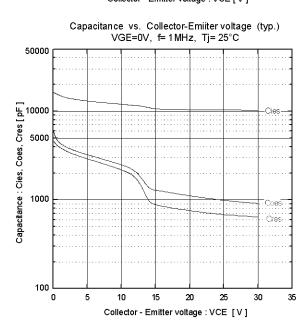
Items	Symbols	Conditions	Cha min.	aracteris typ.	ics max.	Units
Thermal registance (devise)		IGBT	-	-	0.16	
mermanesistance (idevice)	Kill(J-C)	FWD	_	_	0.33	°C/W
Contact thermal resistance	Rth(c-f)	with Thermal Compound (*3)	_	0.025	-	

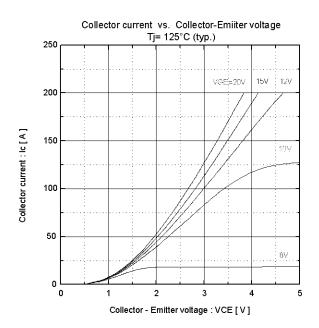
Note *3: This is the value which is defined mounting on the additional cooling fin with thermal compound.

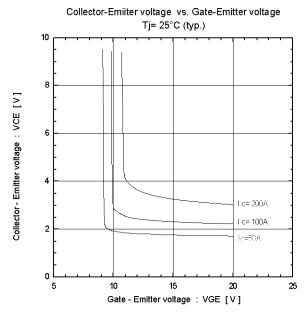
■ Characteristics (Representative)

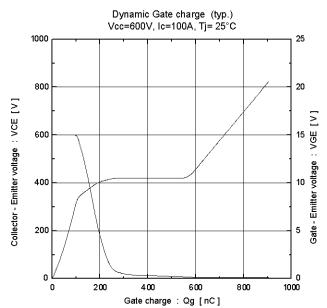


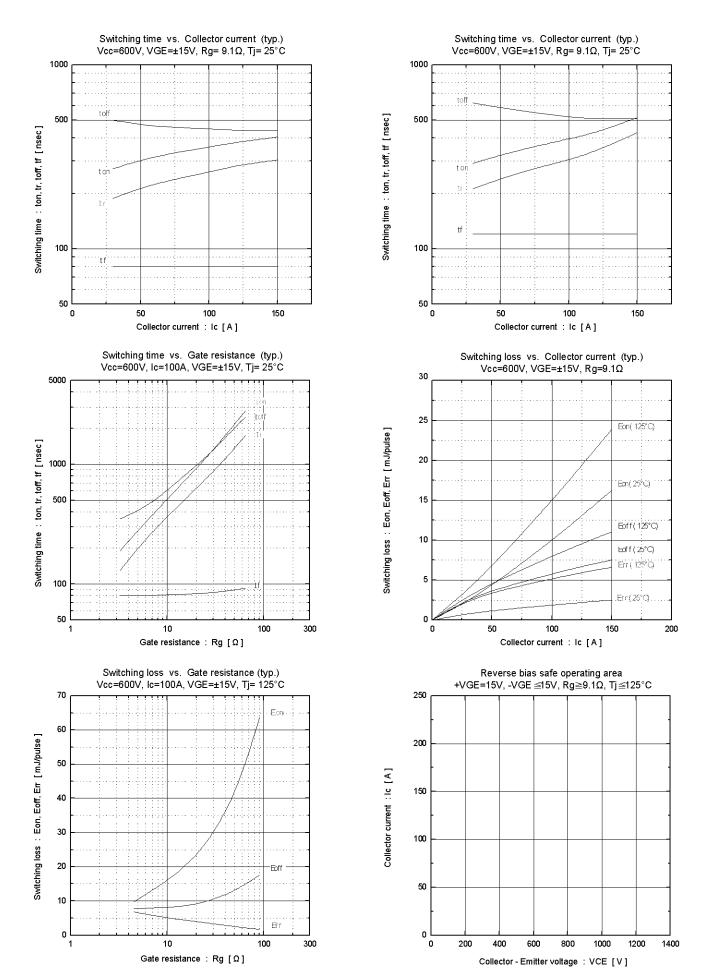


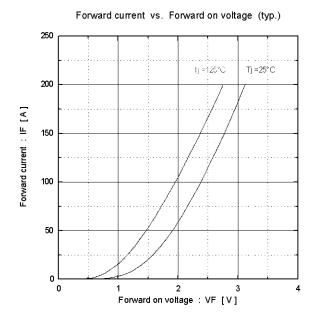


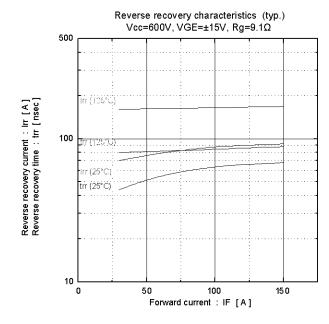


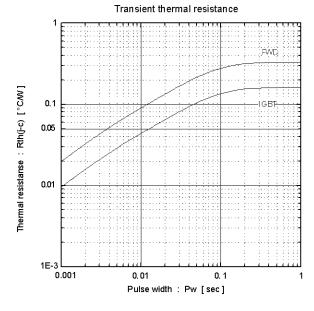




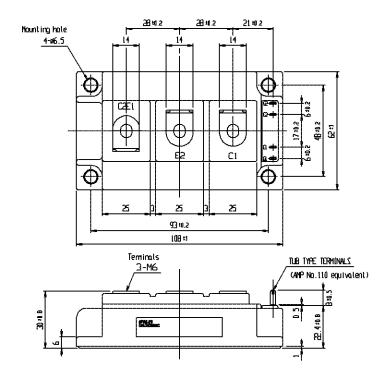




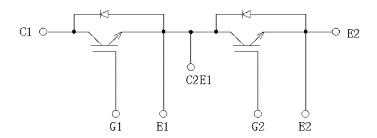




■ Outline Drawings, mm



■ Equivalent Circuit Schematic



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